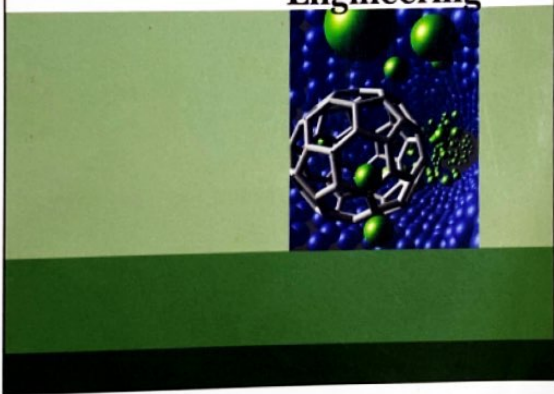




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William F. Smith

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of **Materials Science** Third Edition
and **Engineering**



McGraw-Hill

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